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|-----|--------|---|---|----|----|------------------|
| L2 | 595306 | (plug neear10 surface near5 barrier near5 layer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:11 |
| L3 | 2052 | (copper near10 surface near5 barrier near5 layer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:11 |
| L4 | 271773 | ((form or forming or formed or formation) near "10" copper near10 surface near5 barrier near5 layer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:12 |
| L5 | 1087 | ((form or forming or formed or formation) near10 copper near10 surface near5 barrier near5 layer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:12 |
| L6 | 772 | ((form or forming or formed or formation) near5 copper near10 surface near5 barrier near5 layer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:12 |
| L7 | 586 | ((form or forming or formed or formation) near5 copper near5 surface near5 barrier near5 layer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:12 |
| L8 | 336 | ((form or forming or formed or formation) near5 copper near5 surface near2 barrier near layer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:12 |
| L9 | 46 | ((form or forming or formed or formation) near5 copper near5 surface near2 barrier near layer). clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:13 |
| L10 | 18 | ((form or forming or formed or formation) near2 copper near5 surface near2 barrier near layer). clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:13 |
| L11 | 4 | ((form or forming or formed or formation) near2 copper near2 surface near2 barrier near layer). clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:18 |

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| L12 | 0 | 10/44864 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:14 |
| L13 | 0 | 10/044864 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:14 |
| L14 | 1 | ((form or forming or formed or formation) near2 copper near2 surface near2 barrier near layer). clm. and (beryllium or magnesium or calcium or strontium or barium or mg or be or ba or ca) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:19 |
| L15 | 0 | ((form or forming or formed or formation) near2 copper near2 surface near2 barrier near layer). clm. and (beryllium or magnesium or calcium or strontium or barium or mg or be or ba or ca).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:19 |
| L16 | 1 | ((form or forming or formed or formation) near5 copper near5 surface near2 barrier near layer). clm. and (beryllium or magnesium or calcium or strontium or barium or mg or be or ba or ca).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:20 |
| L17 | 0 | ((form or forming or formed or formation) near5 copper near5 surface near2 barrier near layer). clm. same (beryllium or magnesium or calcium or strontium or barium or mg or be or ba or ca).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:20 |
| L18 | 14 | ((form or forming or formed or formation) near5 copper near5 surface near2 barrier near layer) same (beryllium or magnesium or calcium or strontium or barium or mg or be or ba or ca) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/01/08 16:20 |